# imall

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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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## APT30DQ60BHB APT30DQ60BHB(G) 600V 2X30A

\*G Denotes RoHS Compliant, Pb Free Terminal Finish.

## **ULTRAFAST SOFT RECOVERY RECTIFIER DIODE**

#### PRODUCT APPLICATIONS

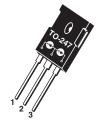
- Anti-Parallel Diode
  -Switchmode Power Supply
  -Inverters
- Free Wheeling Diode
  -Motor Controllers
  -Converters
  -Inverters
- Snubber Diode
- PFC
- RoHS Compliant

#### **PRODUCT FEATURES**

- Ultrafast Recovery Times
- Soft Recovery Characteristics
- Popular TO-247 Package or Surface Mount D<sup>3</sup>PAK Package
- Low Forward Voltage
- Low Leakage Current
- Avalanche Energy Rated

#### PRODUCT BENEFITS

- Low Losses
- Low Noise Switching
- Cooler Operation
- · Higher Reliability Systems
- Increased System Power Density



1 - Cathode 1
2 - Anode 1
Cathode 2
3 - Anode 2

#### **MAXIMUM RATINGS**

All Ratings per diode:  $T_{C} = 25^{\circ}C$  unless otherwise specified.

Symbol	Characteristic / Test Conditions	APT30DQ60BHB(G)	UNIT
V <sub>R</sub>	Maximum D.C. Reverse Voltage		
V <sub>RRM</sub>	Maximum Peak Repetitive Reverse Voltage	600	Volts
V <sub>RWM</sub>	Maximum Working Peak Reverse Voltage		
I <sub>F(AV)</sub>	Maximum Average Forward Current (T <sub>C</sub> = 67°C, Duty Cycle = 0.5)	30	
I <sub>F(RMS)</sub>	RMS Forward Current (Square wave, 50% duty)	51	Amps
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current ( $T_J = 45^{\circ}C$ , 8.3ms)	320	
E <sub>AVL</sub>	Avalanche Energy (1A, 40mH)	20	mJ
T <sub>J</sub> ,T <sub>STG</sub>	Operating and StorageTemperature Range	-55 to 175	*0
TL	Lead Temperature for 10 Sec.	300	°C

#### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		MIN	ТҮР	МАХ	UNIT
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 30A		2.0	2.4	
		I <sub>F</sub> = 60A		2.4		Volts
		I <sub>F</sub> = 30A, T <sub>J</sub> = 125°C		1.7		
I <sub>RM</sub>	Maximum Reverse Leakage Current	V <sub>R</sub> = 600V			25	
		V <sub>R</sub> = 600V, T <sub>J</sub> = 125°C			500	μA
C <sub>T</sub>	Junction Capacitance, V <sub>R</sub> = 200V			36		pF

#### **DYNAMIC CHARACTERISTICS**

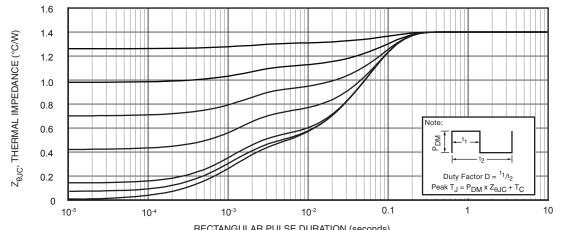
#### APT30DQ60BHB(G)

Symbol	Characteristic	Test Conditions	MIN	ТҮР	МАХ	UNIT
t <sub>rr</sub>	Reverse Recovery Time $I_F = 1A, di_F/dt =$	Reverse Recovery Time $I_F = 1A$ , $di_F/dt = -100A/\mu s$ , $V_R = 30V$ , $T_J = 25^{\circ}C$		23		ns
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 30A, di <sub>F</sub> /dt = -200A/µs V <sub>R</sub> = 400V, T <sub>C</sub> = 25°C	-	30		115
Q <sub>rr</sub>	Reverse Recovery Charge		-	55		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	3	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 30A, di <sub>F</sub> /dt = -200A/µs V <sub>R</sub> = 400V, T <sub>C</sub> = 125°C	-	175		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	485		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	6	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 30A, di <sub>F</sub> /dt = -1000A/μs V <sub>R</sub> = 400V, T <sub>C</sub> = 125°C	-	75		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	855		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	22		Amps

#### THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	ТҮР	МАХ	UNIT
R <sub>θJC</sub>	Junction-to-Case Thermal Resistance			1.5	°C/W
W <sub>T</sub>	Package Weight		0.22		οz
			5.9		g
Torque	Maximum Mounting Torque			10	lb•in
				1.1	N•m

Microsemi reserves the right to change, without notice, the specifications and information contained herein.



RECTANGULAR PULSE DURATION (seconds) FIGURE 1a. MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs. PULSE DURATION

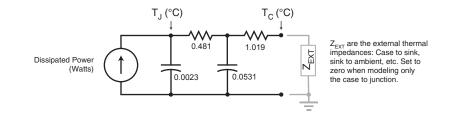
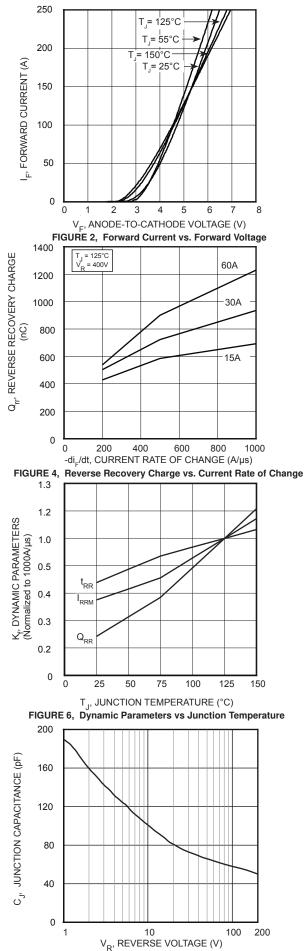
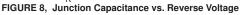


FIGURE 1b, TRANSIENT THERMAL IMPEDANCE MODEL

#### **TYPICAL PERFORMANCE CURVES**

APT30DQ60BHB(G)





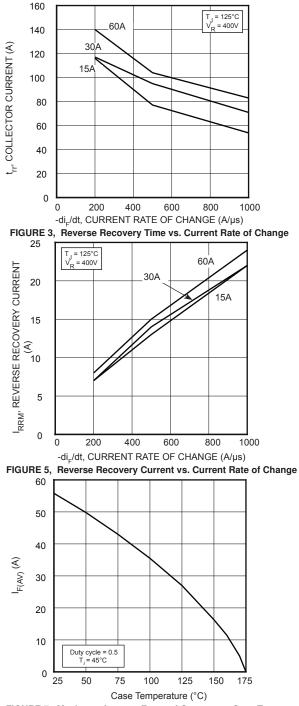


FIGURE 7, Maximum Average Forward Current vs. Case Temperature

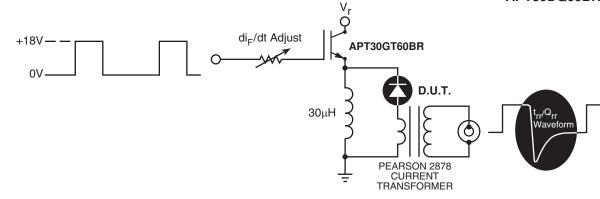


Figure 9. Diode Test Circuit

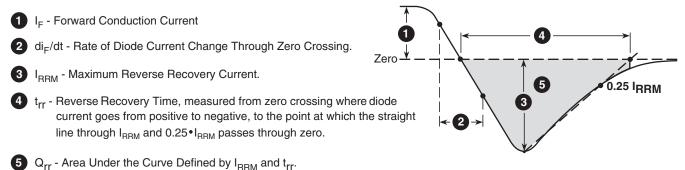
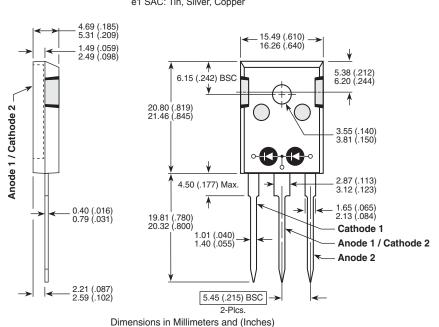


Figure 10, Diode Reverse Recovery Waveform and Definitions



# **TO-247 Package Outline**

e1 SAC: Tin, Silver, Copper